



Data Sheet

Customer: _____

Part No: _____

CL-BIT1608UHY-02(5mA)

Sample No: _____

Description: _____

Item No: _____

Customer			
Check	Inspection	Approval	Date

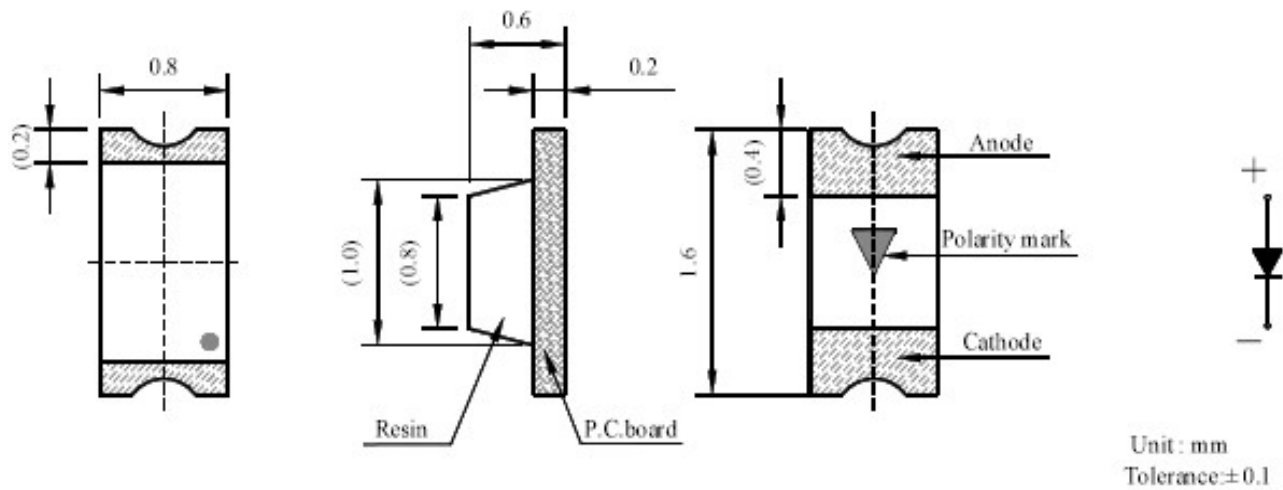
Features

- _1.6mmX0.8mm SMT LED, 0.60mm THICKNESS.
- _LOW POWER CONSUMPTION.
- _WIDE VIEWING ANGLE.
- _IDEAL FOR BACKLIGHT AND INDICATOR.
- _VARIOUS COLORS AND LENS TYPES AVAILABLE.
- _PACKAGE: 4000PCS / REEL.
- _RoHS COMPLIANT.

Description

The Yellow source color devices are made with
Gallium
Arsenide Phosphide on Gallium Phosphide
Yellow Light

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.1 (0.004") unless otherwise noted.
3. Specifications are subject to change without notice.

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) @ 5mA		Viewing Angle
			Min.	Typ.	2 θ 1/2
CL-BIT1608UHY-02	YELLOW (GaAsP/GaP)	WATER CLEAR	22.5	45	120

Note:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Min	Max.	Units	Test Conditions
λ _{peak}	Peak Wavelength	Yellow	586	594	nm	IF=5mA
λ _D	Dominant Wavelength	Yellow			nm	IF=5mA
Δλ _{1/2}	Spectral Line Half-width	Yellow			nm	IF=5mA
C	Capacitance	Yellow	20		pF	VF=0V;f=1MHz
VF	Forward Voltage	Yellow	1.7	2.1	V	IF=5mA
IR	Reverse Current	Yellow		2	uA	VR = 7V

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous Intensity: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters

Absolute Maximum Ratings at TA=25°C

Parameter	YELLOW	Units
Power dissipation	75	mW
DC Forward Current	30	mA
Peak Forward Current [1]	80	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

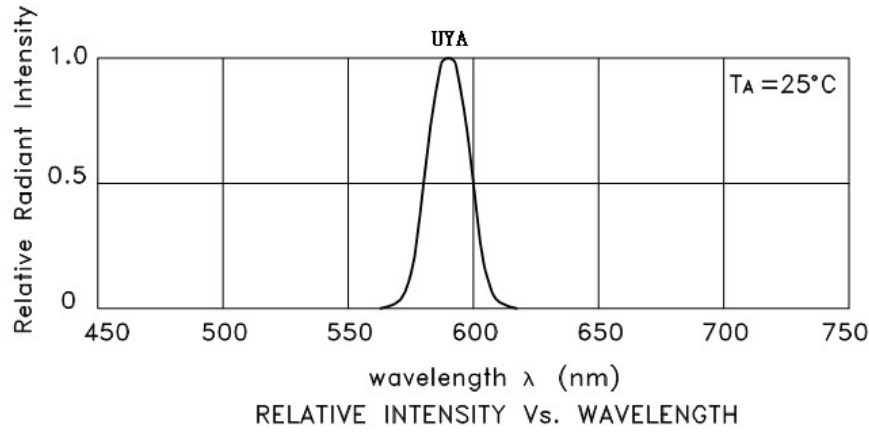
Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

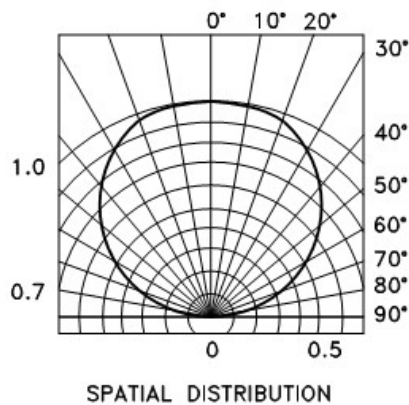
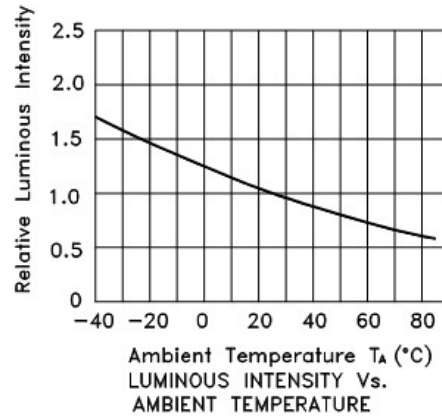
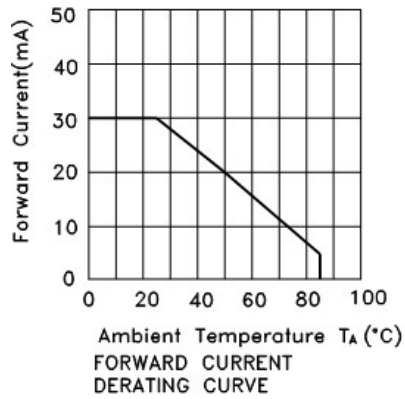
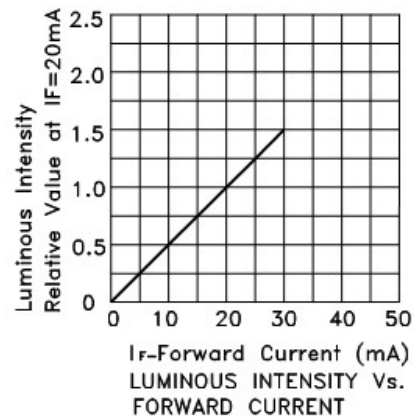
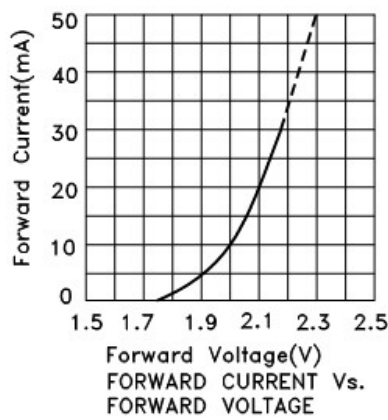
BIN Code	Test Condition @5mA	
UHY	Vfmin(v)	Vfmax (v)
1	1.7	1.8
2	1.8	1.9
3	1.9	2.0
4	2.0	2.1

BIN Code	Test condition: 5mA	
UHY	λ_{dmin} (nm)	λ_{dmax} (nm)
1	586	588
2	588	590
3	590	592
4	592	594

BIN Code	Test condition: @5mA	
UHY	IVmin(mcd)	IVmax (mcd)
1	22.5	28.5
2	28.5	36
3	36	45



CL-BIT1608UHY-02 (5mA)



RELIABILITY

Test Items and Results

NO	SYMBOL	Guideline	Test conditions	Duration	Number of samples	Acceptance level (number of unqualified items/total number of samples)
1	temperature cycle	JEITA ED-4701	-40℃ ~ 25℃ ~ 100℃ ~ 25℃ 30 MIN 5 MIN 30 MIN 5 MIN	Loop 100 rounds	50	0/50
2	Thermal shock	MIL-STD-202G	-40℃ ~ 100℃ 15 MIN 15 MIN	Loop 500 rounds	50	0/50
3	high temperature storage	JEITA ED-4701 200 201	T _a =100℃	1000 hour	50	0/50
4	Low temperature storage	JEITA ED-4701 200 201	T _a =-40℃	1000 hour	50	0/50
5	Normal temperature life test		T _a =25±5℃ I _F =20mA	1000 hour	50	0/50
6	High temperature and high humidity life test		T _a =60℃ RH=85% I _F =20mA	1000 hour	50	0/50
7	Solderability (reflow soldering)	JEITA ED-4701 300 303	T _{sol} =235℃±5℃, 5 秒 Use flux	Weld once, 5 seconds	10	0/10
8	Solder resistance (reflow soldering)	JEITA ED-4701 300 301	T _{sol} =260℃, 10 SEC preprocessing : 35℃ 95%RH 96HOUR	Weld twice, 10 seconds each time	10	0/10
Prepare	If the above test items are different from the customer's test requirements or have special customer requirements, they can be trial-produced according to the actual situation and in accordance with the customer's requirements. If the customer does not require it, the trial-production should be carried out according to our company's test standards. Different products use different currents for testing.					

5. Cautions

(1) Soldering Conditions

Number of reflow process shall be less than 2 times and cooling process to normal temperature

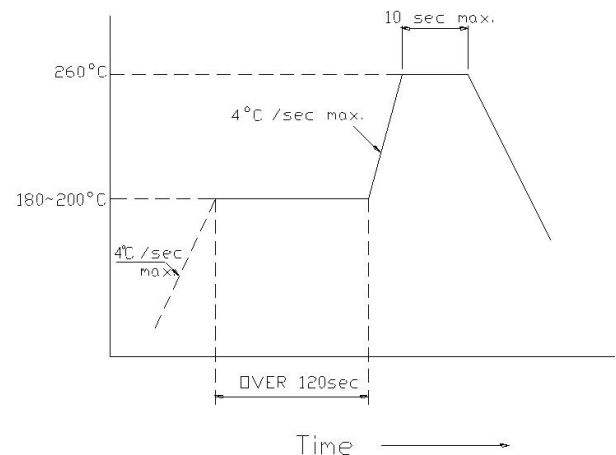
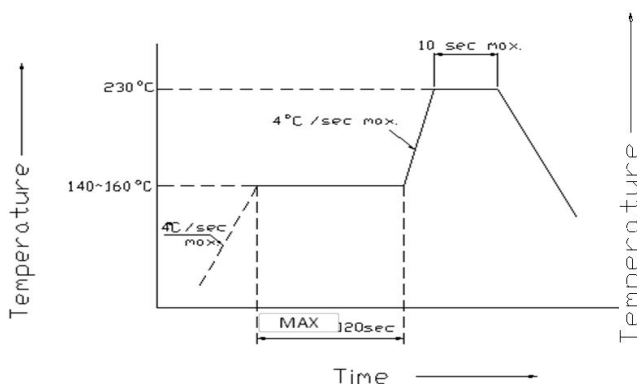
is required between first and Second soldering process.

(Recommended soldering conditions)

回流焊接 Reflow Soldering			手工焊接	
预热温度 Pre-heat	有铅 Lead Solder	无铅 Lead-free Solder	温度 Temperature	350° C Max.
预热时间 Pre-heat time	140 ~ 160° C 120 sec. Max.	180 ~ 200° C 120 sec. Max.	焊接时间 Soldering time	3 sec. Max. (one time only)
峰值温度 Peak temperature	230° C Max. 10 sec. Max.	260° C Max. 10 sec. Max.		
焊接时间 Soldering time	参考下图	参考下图		
条件 Condition				

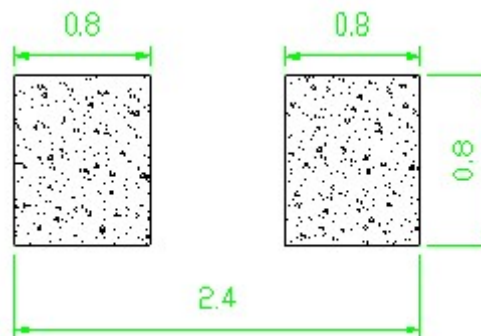
(Lead Solder)

(Lead-Free Solder)



Recommended Soldering Pattern

(Units : mm)



(2) Static Electricity

It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.

All devices, equipment and machinery must be properly grounded.

2.0V Damaged LEDs will show some unusual characteristics such as the forward voltage becomes lower, or the LEDs do not light at the low current. Criteria : ($V_F > 2.0V$ at $I_F=0.5mA$)

(3) Moisture Proof Package

It is recommended that moisture proof package be used .

(4)

Cautions:

4.1.

Please check if there is air leak before opening the package, if so, please return the goods back to take drying process for later using.

4.2

Products can be used within 15days after packaging, after that, they must be:

4.2.1

Soldered within 24 hrs

4.2.2

Used in the condition: $30^{\circ}C$ within and 60%RH below

4.2.3 30%RH ◦

Stored in 30%RH for moisture below.

4.3.

Products cannot be used for and over 15days after being packaged unless opening the package and take drying our process in $85^{\circ}C/6H$.

4.4.

Products not be used for or over 60days after being packaged please return back to take drying out and packaging process for forward using.

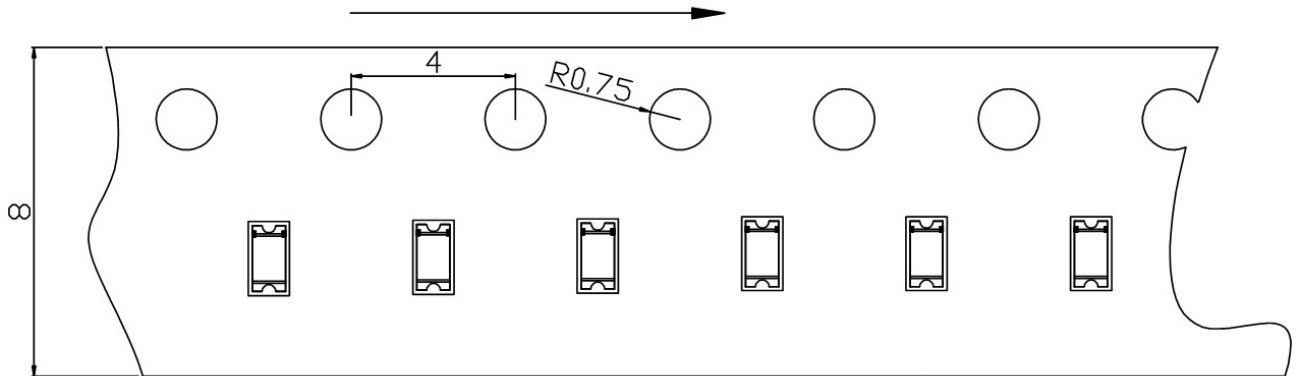
4.5. Products not be used after opening the package need to be dried out for $85^{\circ}C/6H$

PACKAGING

The LEDs are packed in cardboard boxes after taping.

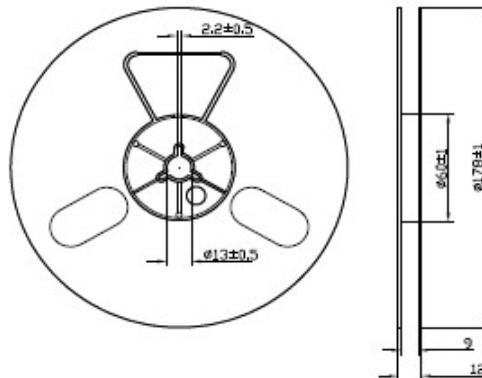
包装方式:

TAPE

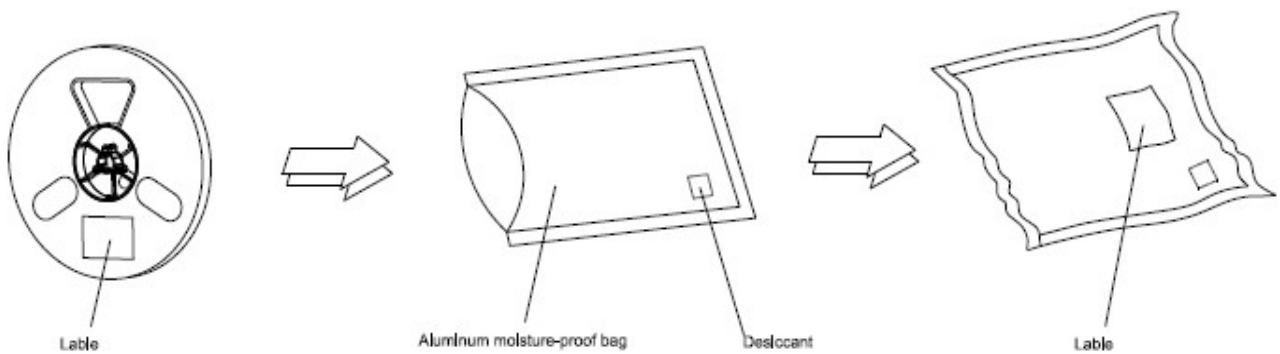


Package: 4000 pcs/reel

Reel Dimensions



Moisture Resistant Packaging



Note: The tolerances unless mentioned is $\pm 0.1\text{mm}$, Unit: mm